

AO4427 30V P-Channel MOSFET

General Description

The AO4427 uses advanced trench technology to provide excellent $R_{\text{DS(ON)}}$, and ultra-low low gate charge with a 25V gate rating. This device is suitable for use as a load switch or in PWM applications. The device is ESD protected.

Product Summary

 $V_{DS}(V) = -30V$

 $I_D = -12.5 \text{ A } (V_{GS} = -20 \text{V})$

 $R_{DS(ON)}$ < 12m Ω (V_{GS} = -20V)

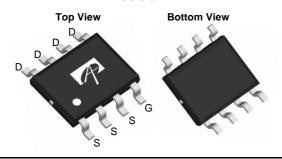
 $R_{DS(ON)} < 14 m\Omega \; (V_{GS} = \text{-}10 \text{V})$

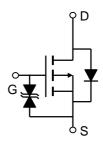
ESD Rating: 2KV HBM

100% UIS Tested 100% Rg Tested









Absolute Maximum Ratings	T _A =25℃ unless otherwise noted

Parameter		Symbol	Maximum	Units
Drain-Source Voltage		V_{DS}	-30	V
Gate-Source Voltage		V_{GS}	±25	V
Continuous Drain	T _A =25℃		-12.5	
Current AF	T _A =70℃	I _D	-10.5	Α
Pulsed Drain Current	В	I _{DM}	-60	
	T _A =25℃	P _D	3	W
Power Dissipation A	T _A =70℃	L D	2.1	VV
Junction and Storage Temperature Range		T_J , T_{STG}	-55 to 150	Ç

Thermal Characteristics						
Parameter		Symbol	Тур	Max	Units	
Maximum Junction-to-Ambient AF	t ≤ 10s	$ R_{\theta JA}$	28	40	€\M	
Maximum Junction-to-Ambient A	Steady-State	Т⊕ЈА	54	75	€\M	
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	21	30	℃/W	

Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC F	PARAMETERS					
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-30			V
I _{DSS} Zero Gate Voltage Drain Current	V _{DS} =-30V, V _{GS} =0V			-1		
	Zero Gate Voltage Drain Current	T _J =55℃			-5	μΑ
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±25V			±10	μΑ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=-250\mu A$	-1.7	-2.5	-3	V
$I_{D(ON)}$	On state drain current	V _{GS} =-10V, V _{DS} =-5V	-60			Α
R _{DS(ON)} Static Drain-Source On-Resistance	V _{GS} =-20V, I _D =-12.5A		9.4	12	m()	
	T _J =125℃		12.2	15	mΩ	
	V _{GS} =-10V, I _D =-10A		11.5	14	mΩ	
		V _{GS} =-4.5V, I _D =-5A		32		mΩ
g _{FS}	Forward Transconductance	V _{DS} =-5V, I _D =-12.5A		24		S
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V			-1	V
I _S	Maximum Body-Diode Continuous Current				-4.2	Α
DYNAMIC	PARAMETERS					
C _{iss}	Input Capacitance			2330	2900	pF
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =-15V, f=1MHz		480		pF
C_{rss}	Reverse Transfer Capacitance]		320	448	pF
R_g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz	3.4	6.8	10	Ω
SWITCHI	NG PARAMETERS					
Q_g	Total Gate Charge	V - 10V V - 15V		41	52	nC
Q_{gs}	Gate Source Charge	-V _{GS} =-10V, V _{DS} =-15V, -I _D =-12.5A		10		nC
Q_{gd}	Gate Drain Charge	1D= 12.0/(12		nC
t _{D(on)}	Turn-On DelayTime			12.8		ns
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-15V, R_L =1.2 Ω ,		10.3		ns
t _{D(off)}	Turn-Off DelayTime	R_{GEN} =3 Ω		49.5		ns
t _f	Turn-Off Fall Time]		29		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-12.5A, dI/dt=100A/μs		28	35	ns
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =-12.5A, dl/dt=100A/μs		20		nC

A: The value of R _{BJA} is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with

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T $_{\rm A}\!\!=\!\!25{\rm ^\circ\!\!C}.$ The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

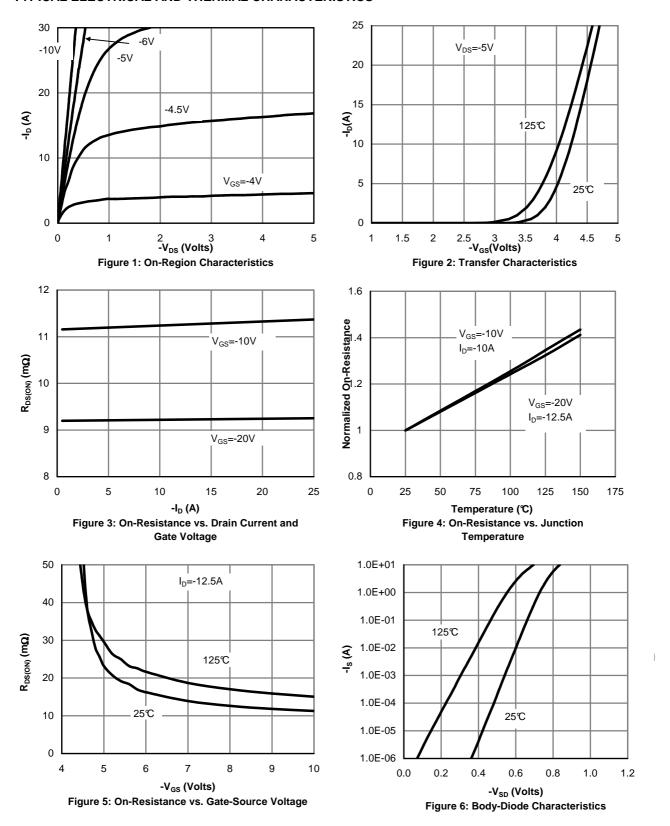
C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.

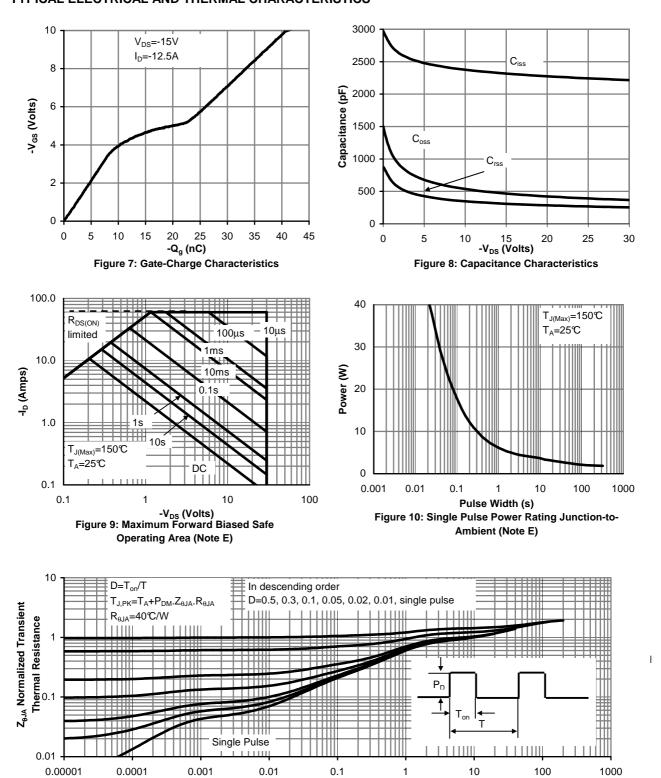
E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T A=25°C. The SOA curve provides a single pulse rating.

F. The current rating is based on the $t \le 10s$ junction to ambient thermal resistance rating. Rev8: Nov. 2010

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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Pulse Width (s)
Figure 11: Normalized Maximum Transient Thermal Impedance